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CMOS process. The detection voltage is fixed internally, with accuracy of  $\pm 2.0\%$ . Two output types, Nch open-drain and CMOS output, are available.

## ■ Features

- Ultra-low current consumption  
1.3  $\mu$ A typ. ( $V_{DD}=1.5$  V)
- Products with detection voltage of 1.4 V or less electronic  
0.8 $\mu$ A typ. ( $V_{DD}=3.5$  V)  
Products with detection voltage of 1.5 V or more
- High-precision detection voltage  
 $\pm 2.0\%$
- Low operating voltage  
0.7 to 5.0 V  
Products with detection voltage of 1.4 V or less  
0.95 to 10.0 V  
Products with a detection voltage of 1.5 V or more
- Hysteresis characteristics  
5% typ.
- Detection voltage  
0.8 to 6.0 V  
(0.1 V step)
- Nch open-drain active low and CMOS active low output
- SC-82AB Super-small plastic package
- TO-92 Plastic package
- SOT-89-3 Miniaturized power mold plastic package
- SOT-23-5 Very-small plastic package

## ■ Applications

- Battery checker
- Power failure detector
- Power monitor for pagers, calculators, organizers,
- Constant voltage power monitor for camera video equipment, communication devices
- Power monitor for microcomputers and res CPUs

## ■ Pin Assignment

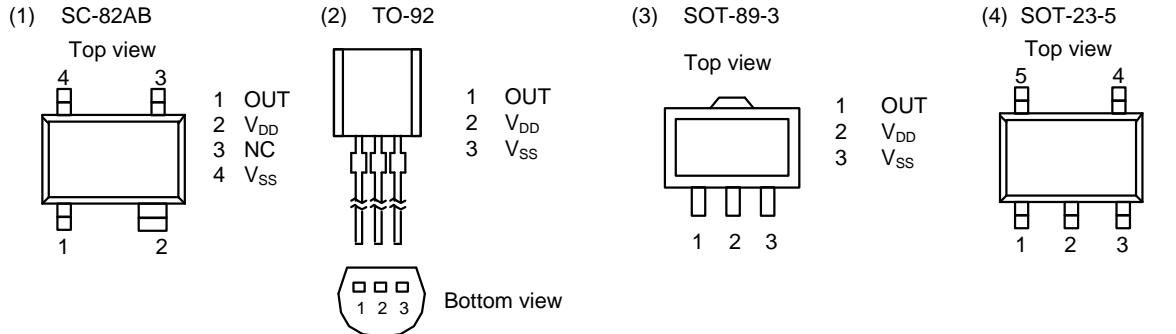
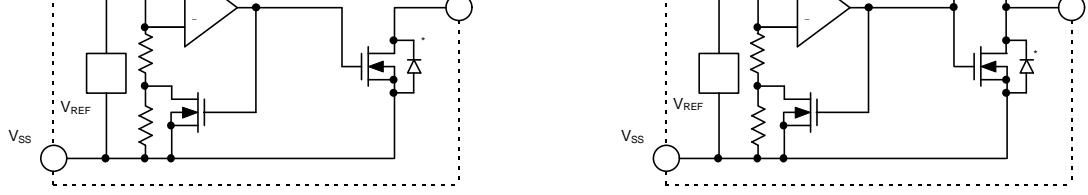


Figure 1

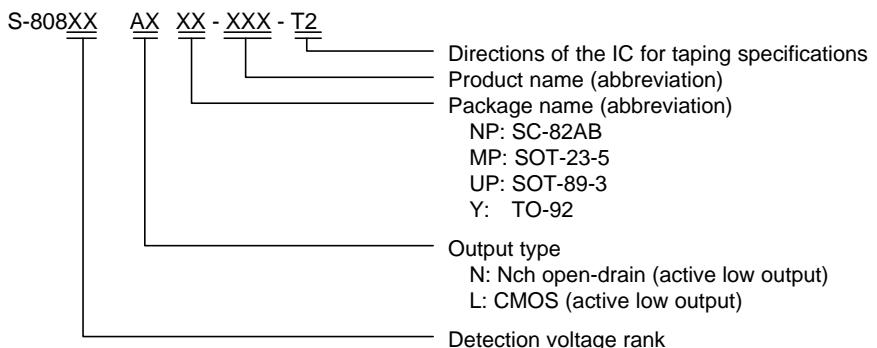
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\*Parasitic diode

**Figure 2**

### ■ Selection Guide



1.1V±2.0%	0.064	S-80811ANNP-E71-T2	—	—	—
1.2V±2.0%	0.073	S-80812ANNP-E72-T2	—	—	—
1.3V±2.0%	0.083	S-80813ANNP-EDA-T2	—	—	—
1.4V±2.0%	0.093	S-80814ANNP-EDB-T2	—	—	—
1.5V±2.0%	0.075	S-80815ANNP-EDC-T2	S-80815ANY	S-80815ANUP-EDC-T2	—
1.6V±2.0%	0.080	S-80816ANNP-EDD-T2	S-80816ANY	S-80816ANUP-EDD-T2	—
1.7V±2.0%	0.085	S-80817ANNP-EDE-T2	S-80817ANY	S-80817ANUP-EDE-T2	S-80817ANMP-ED
1.8V±2.0%	0.090	S-80818ANNP-EDF-T2	S-80818ANY	S-80818ANUP-EDF-T2	S-80818ANMP-ED
1.9V±2.0%	0.095	S-80819ANNP-EDG-T2	S-80819ANY	S-80819ANUP-EDG-T2	S-80819ANMP-ED
2.0V±2.0%	0.100	S-80820ANNP-EDH-T2	S-80820ANY	S-80820ANUP-EDH-T2	S-80820ANMP-ED
2.1V±2.0%	0.105	S-80821ANNP-EDJ-T2	S-80821ANY	S-80821ANUP-EDJ-T2	S-80821ANMP-ED
2.2V±2.0%	0.110	S-80822ANNP-EDK-T2	S-80822ANY	S-80822ANUP-EDK-T2	S-80822ANMP-ED
2.3V±2.0%	0.115	S-80823ANNP-EDL-T2	S-80823ANY	S-80823ANUP-EDL-T2	S-80823ANMP-ED
2.4V±2.0%	0.120	S-80824ANNP-EDM-T2	S-80824ANY	S-80824ANUP-EDM-T2	S-80824ANMP-ED
2.5V±2.0%	0.125	S-80825ANNP-EDN-T2	S-80825ANY	S-80825ANUP-EDN-T2	S-80825ANMP-ED
2.6V±2.0%	0.130	S-80826ANNP-EDP-T2	S-80826ANY	S-80826ANUP-EDP-T2	—
2.7V±2.0%	0.135	S-80827ANNP-EDQ-T2	S-80827ANY	S-80827ANUP-EDQ-T2	S-80827ANMP-ED
2.8V±2.0%	0.140	S-80828ANNP-EDR-T2	S-80828ANY	S-80828ANUP-EDR-T2	S-80828ANMP-ED
2.9V±2.0%	0.145	S-80829ANNP-EDS-T2	S-80829ANY	S-80829ANUP-EDS-T2	—
3.0V±2.0%	0.150	S-80830ANNP-EDT-T2	S-80830ANY	S-80830ANUP-EDT-T2	S-80830ANMP-ED
3.1V±2.0%	0.155	S-80831ANNP-EDV-T2	S-80831ANY	S-80831ANUP-EDV-T2	—
3.2V±2.0%	0.160	S-80832ANNP-EDW-T2	S-80832ANY	S-80832ANUP-EDW-T2	S-80832ANMP-ED
3.3V±2.0%	0.165	S-80833ANNP-EDX-T2	S-80833ANY	S-80833ANUP-EDX-T2	S-80833ANMP-ED
3.4V±2.0%	0.170	S-80834ANNP-EDY-T2	S-80834ANY	S-80834ANUP-EDY-T2	S-80834ANMP-ED
3.5V±2.0%	0.175	S-80835ANNP-EDZ-T2	S-80835ANY	S-80835ANUP-EDZ-T2	S-80835ANMP-ED
3.6V±2.0%	0.180	S-80836ANNP-ED0-T2	S-80836ANY	S-80836ANUP-ED0-T2	S-80836ANMP-ED
3.7V±2.0%	0.185	S-80837ANNP-ED1-T2	S-80837ANY	S-80837ANUP-ED1-T2	—
3.8V±2.0%	0.190	S-80838ANNP-ED2-T2	S-80838ANY	S-80838ANUP-ED2-T2	—
3.9V±2.0%	0.195	S-80839ANNP-ED3-T2	S-80839ANY	S-80839ANUP-ED3-T2	S-80839ANMP-ED
4.0V±2.0%	0.200	S-80840ANNP-ED4-T2	S-80840ANY	S-80840ANUP-ED4-T2	S-80840ANMP-ED
4.1V±2.0%	0.205	S-80841ANNP-ED5-T2	S-80841ANY	S-80841ANUP-ED5-T2	—
4.2V±2.0%	0.210	S-80842ANNP-ED6-T2	S-80842ANY	S-80842ANUP-ED6-T2	S-80842ANMP-ED
4.3V±2.0%	0.215	S-80843ANNP-ED7-T2	S-80843ANY	S-80843ANUP-ED7-T2	—
4.4V±2.0%	0.220	S-80844ANNP-ED8-T2	S-80844ANY	S-80844ANUP-ED8-T2	S-80844ANMP-ED
4.5V±2.0%	0.225	S-80845ANNP-ED9-T2	S-80845ANY	S-80845ANUP-ED9-T2	S-80845ANMP-ED
4.6V±2.0%	0.230	S-80846ANNP-EJA-T2	S-80846ANY	S-80846ANUP-EJA-T2	—
4.7V±2.0%	0.235	S-80847ANNP-EJB-T2	S-80847ANY	S-80847ANUP-EJB-T2	—
4.8V±2.0%	0.240	S-80848ANNP-EJC-T2	S-80848ANY	S-80848ANUP-EJC-T2	—
4.9V±2.0%	0.245	S-80849ANNP-EJD-T2	S-80849ANY	S-80849ANUP-EJD-T2	—
5.0V±2.0%	0.250	S-80850ANNP-EJE-T2	S-80850ANY	S-80850ANUP-EJE-T2	S-80850ANMP-EJ
5.1V±2.0%	0.255	S-80851ANNP-EJF-T2	S-80851ANY	S-80851ANUP-EJF-T2	S-80851ANMP-EJ
5.2V±2.0%	0.260	S-80852ANNP-EJG-T2	—	S-80852ANUP-EJG-T2	—
5.3V±2.0%	0.265	S-80853ANNP-EJH-T2	S-80853ANY	—	—
5.4V±2.0%	0.270	S-80854ANNP-EJJ-T2	—	—	—
5.5V±2.0%	0.275	S-80855ANNP-EJK-T2	—	—	—
5.6V±2.0%	0.280	S-80856ANNP-EJL-T2	—	—	—
5.7V±2.0%	0.285	S-80857ANNP-EJM-T2	—	—	—
5.8V±2.0%	0.290	S-80858ANNP-EJN-T2	—	—	—
5.9V±2.0%	0.295	S-80859ANNP-EJP-T2	—	—	—
6.0V±2.0%	0.300	S-80860ANNP-EJQ-T2	—	S-80860ANUP-EJQ-T2	—

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1.1V±2.0%	0.064	S-80811ALNP-E51-T2	—	—	—
1.2V±2.0%	0.073	S-80812ALNP-E52-T2	—	—	—
1.3V±2.0%	0.083	S-80813ALNP-EAA-T2	—	—	—
1.4V±2.0%	0.093	S-80814ALNP-EAB-T2	—	—	—
1.5V±2.0%	0.075	S-80815ALNP-EAC-T2	S-80815ALY	S-80815ALUP-EAC-T2	S-80815ALMP-EAC-T2
1.6V±2.0%	0.080	S-80816ALNP-EAD-T2	S-80816ALY	S-80816ALUP-EAD-T2	—
1.7V±2.0%	0.085	S-80817ALNP-EAE-T2	S-80817ALY	S-80817ALUP-EAE-T2	—
1.8V±2.0%	0.090	S-80818ALNP-EAF-T2	S-80818ALY	S-80818ALUP-EAF-T2	S-80818ALMP-EAF-T2
1.9V±2.0%	0.095	S-80819ALNP-EAG-T2	S-80819ALY	S-80819ALUP-EAG-T2	S-80819ALMP-EAG-T2
2.0V±2.0%	0.100	S-80820ALNP-EAH-T2	S-80820ALY	S-80820ALUP-EAH-T2	S-80820ALMP-EAH-T2
2.1V±2.0%	0.105	S-80821ALNP-EAJ-T2	S-80821ALY	S-80821ALUP-EAJ-T2	S-80821ALMP-EAJ-T2
2.2V±2.0%	0.110	S-80822ALNP-EAK-T2	S-80822ALY	S-80822ALUP-EAK-T2	—
2.3V±2.0%	0.115	S-80823ALNP-EAL-T2	S-80823ALY	S-80823ALUP-EAL-T2	S-80823ALMP-EAL-T2
2.4V±2.0%	0.120	S-80824ALNP-EAM-T2	S-80824ALY	S-80824ALUP-EAM-T2	—
2.5V±2.0%	0.125	S-80825ALNP-EAN-T2	S-80825ALY	S-80825ALUP-EAN-T2	S-80825ALMP-EAN-T2
2.6V±2.0%	0.130	S-80826ALNP-EAP-T2	S-80826ALY	S-80826ALUP-EAP-T2	—
2.7V±2.0%	0.135	S-80827ALNP-EAQ-T2	S-80827ALY	S-80827ALUP-EAQ-T2	S-80827ALMP-EAQ-T2
2.8V±2.0%	0.140	S-80828ALNP-EAR-T2	S-80828ALY	S-80828ALUP-EAR-T2	S-80828ALMP-EAR-T2
2.9V±2.0%	0.145	S-80829ALNP-EAS-T2	S-80829ALY	S-80829ALUP-EAS-T2	—
3.0V±2.0%	0.150	S-80830ALNP-EAT-T2	S-80830ALY	S-80830ALUP-EAT-T2	S-80830ALMP-EAT-T2
3.1V±2.0%	0.155	S-80831ALNP-EAV-T2	S-80831ALY	S-80831ALUP-EAV-T2	—
3.2V±2.0%	0.160	S-80832ALNP-EAW-T2	S-80832ALY	S-80832ALUP-EAW-T2	S-80832ALMP-EAW-T2
3.3V±2.0%	0.165	S-80833ALNP-EAX-T2	S-80833ALY	S-80833ALUP-EAX-T2	S-80833ALMP-EAX-T2
3.4V±2.0%	0.170	S-80834ALNP-EAY-T2	S-80834ALY	S-80834ALUP-EAY-T2	—
3.5V±2.0%	0.175	S-80835ALNP-EAZ-T2	S-80835ALY	S-80835ALUP-EAZ-T2	S-80835ALMP-EAZ-T2
3.6V±2.0%	0.180	S-80836ALNP-EA0-T2	S-80836ALY	S-80836ALUP-EA0-T2	—
3.7V±2.0%	0.185	S-80837ALNP-EA1-T2	S-80837ALY	S-80837ALUP-EA1-T2	—
3.8V±2.0%	0.190	S-80838ALNP-EA2-T2	S-80838ALY	S-80838ALUP-EA2-T2	—
3.9V±2.0%	0.195	S-80839ALNP-EA3-T2	S-80839ALY	S-80839ALUP-EA3-T2	—
4.0V±2.0%	0.200	S-80840ALNP-EA4-T2	S-80840ALY	S-80840ALUP-EA4-T2	S-80840ALMP-EA4-T2
4.1V±2.0%	0.205	S-80841ALNP-EA5-T2	S-80841ALY	S-80841ALUP-EA5-T2	—
4.2V±2.0%	0.210	S-80842ALNP-EA6-T2	S-80842ALY	S-80842ALUP-EA6-T2	S-80842ALMP-EA6-T2
4.3V±2.0%	0.215	S-80843ALNP-EA7-T2	S-80843ALY	S-80843ALUP-EA7-T2	—
4.4V±2.0%	0.220	S-80844ALNP-EA8-T2	S-80844ALY	S-80844ALUP-EA8-T2	—
4.5V±2.0%	0.225	S-80845ALNP-EA9-T2	S-80845ALY	S-80845ALUP-EA9-T2	S-80845ALMP-EA9-T2
4.6V±2.0%	0.230	S-80846ALNP-EEA-T2	S-80846ALY	S-80846ALUP-EEA-T2	—
4.7V±2.0%	0.235	S-80847ALNP-EEB-T2	S-80847ALY	S-80847ALUP-EEB-T2	—
4.8V±2.0%	0.240	S-80848ALNP-EEC-T2	S-80848ALY	S-80848ALUP-EEC-T2	—
4.9V±2.0%	0.245	S-80849ALNP-EED-T2	S-80849ALY	S-80849ALUP-EED-T2	S-80849ALMP-EED-T2
5.0V±2.0%	0.250	S-80850ALNP-EEE-T2	S-80850ALY	S-80850ALUP-EEE-T2	S-80850ALMP-EEE-T2
5.1V±2.0%	0.255	S-80851ALNP-EEF-T2	S-80851ALY	S-80851ALUP-EEF-T2	S-80851ALMP-EEF-T2
5.2V±2.0%	0.260	S-80852ALNP-EEG-T2	—	S-80852ALUP-EEG-T2	S-80852ALMP-EEG-T2
5.3V±2.0%	0.265	S-80853ALNP-EEH-T2	—	—	—
5.4V±2.0%	0.270	S-80854ALNP-EEJ-T2	—	—	—
5.5V±2.0%	0.275	S-80855ALNP-EEK-T2	—	S-80855ALUP-EEK-T2	—
5.6V±2.0%	0.280	S-80856ALNP-EEL-T2	—	—	—
5.7V±2.0%	0.285	S-80857ALNP-EEM-T2	—	—	—
5.8V±2.0%	0.290	S-80858ALNP-EEN-T2	—	—	—
5.9V±2.0%	0.295	S-80859ALNP-EEP-T2	—	—	—
6.0V±2.0%	0.300	S-80860ALNP-EEQ-T2	—	—	—

Remark: Some products described here in are under development. Please contact us for Samples.

## 2. Output configurations and their implementation

Implementation	Nch("L")	CMOS("L")
With different power supplies	Yes	No
With active low reset CPUs	Yes	Yes
With active high reset CPUs	No	No
With voltage divider variable resistors	Yes	No

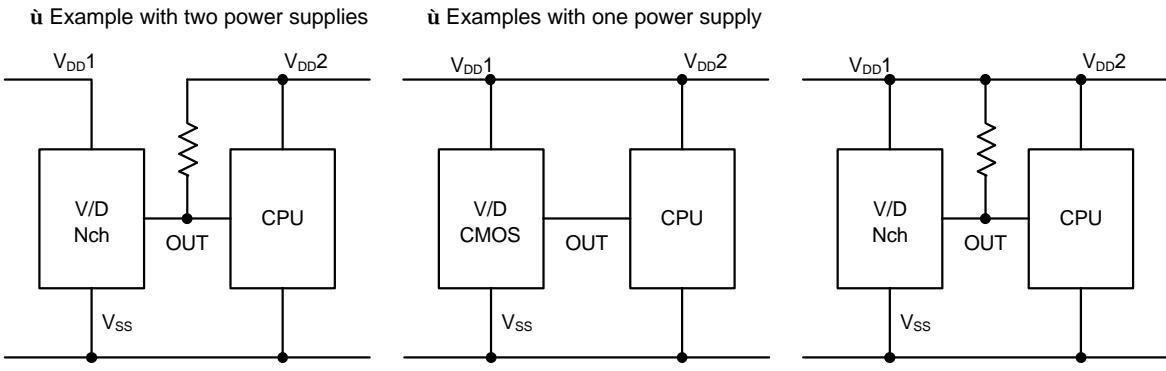


Figure 3

Output voltage	Nch open-drain	$V_{OUT}$	$V_{SS}-0.3$ to 7	V
	CMOS		$V_{SS}-0.3$ to $V_{DD}+0.3$	V
Output current		$I_{OUT}$	50	mA
Power dissipation		Pd	150	mW
Operating temperature		Topr	-20 to +70	°C
Storage temperature		Tstg	-40 to +125	°C

2. Products with detection voltage of 1.5 V or more

(Unless otherwise specified: Ta=25°C)

Parameter		Symbol	Ratings	Unit
Power supply voltage		$V_{DD} - V_{SS}$	12	V
Output voltage	Nch open-drain	$V_{OUT}$	$V_{SS}-0.3$ to 12	V
	CMOS		$V_{SS}-0.3$ to $V_{DD}+0.3$	V
Output current		$I_{OUT}$	50	mA
Power dissipation	Pd	TO-92	400	mW
		SOT-89-3	500	
		SC-82AB,SOT-23-5	150	
Operating temperature		Topr	-40 to +85	°C
Storage temperature		Tstg	-40 to +125	°C

Remark: This IC has a built-in protection circuit for static electricity. However, prevent contact with a large static electricity or electrostatic voltage which exceeds the performance of the protection circuit

			S-80808AX	0.784	0.800	0.816		
			S-80809AX	0.882	0.900	0.918		
			S-80810AX	0.980	1.000	1.020		
			S-80811AX	1.078	1.100	1.122		
			S-80812AX	1.176	1.200	1.224		
Detection voltage	-V <sub>DET</sub>		S-80813AX	1.274	1.300	1.326	V	1
			S-80814AX	1.372	1.400	1.428		
			S-80808AX	0.802	0.834	0.867		
			S-80809AX	0.910	0.944	0.979		
			S-80810AX	1.017	1.054	1.091		
Release voltage	+V <sub>DET</sub>		S-80811AX	1.125	1.164	1.203	V	1
			S-80812AX	1.232	1.273	1.315		
			S-80813AX	1.340	1.383	1.427		
			S-80814AX	1.448	1.493	1.538		
			S-80808AX	0.018	0.034	0.051		
			S-80809AX	0.028	0.044	0.061		
Hysteresis width	V <sub>HYS</sub>		S-80810AX	0.037	0.054	0.071	V	1
			S-80811AX	0.047	0.064	0.081		
			S-80812AX	0.056	0.073	0.091		
			S-80813AX	0.066	0.083	0.101		
			S-80814AX	0.076	0.093	0.110		
			S-80808AX					
			S-80809AX					
Current consumption	I <sub>SS</sub>	V <sub>DD</sub> =1.5V	S-80810AX					
		V <sub>DD</sub> =2.0V	S-80811AX	—	1.3	3.7	μA	2
			S-80812AX					
			S-80813AX					
			S-80814AX					
Operating voltage	V <sub>DD</sub>			0.7	—	5.0	V	1
			Nch	V <sub>DS</sub> =0.5V	0.04	0.2	—	
Output current	I <sub>OUT</sub>			V <sub>DD</sub> =0.7V		—		
			Pch(CMOS output)	V <sub>DS</sub> =2.1V	2.9	5.8	—	mA
				V <sub>DD</sub> =4.5V				4
Leakage current of output transistor	I <sub>LEAK</sub>	Nch(Nch open drain)	V <sub>DS</sub> =5.0V V <sub>DD</sub> =5.0V	—	—	60	nA	3
Temperature characteristic of -V <sub>DET</sub>	$\frac{\Delta V_{DET}}{\Delta T_a}$	T <sub>a</sub> =-20°C to +70°C	S-80808AX	—	±0.18	—	mV/°C	1
			S-80809AX	—	±0.20	—		
			S-80810AX	—	±0.22	—		
			S-80811AX	—	±0.24	—		
			S-80812AX	—	±0.27	—		
			S-80813AX	—	±0.29	—		
			S-80814AX	—	±0.31	—		

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		S-80815AX	1.666	1.700	1.734			
		S-80816AX	1.764	1.800	1.836			
		S-80819AX	1.862	1.900	1.938			
		S-80820AX	1.960	2.000	2.040			
		S-80821AX	2.058	2.100	2.142			
		S-80822AX	2.156	2.200	2.244			
		S-80823AX	2.254	2.300	2.346			
		S-80824AX	2.352	2.400	2.448			
		S-80825AX	2.450	2.500	2.550			
		S-80826AX	2.548	2.600	2.652			
Hysteresis width	V <sub>HYS</sub>		-V <sub>DET</sub> ×0.03	-V <sub>DET</sub> ×0.05	-V <sub>DET</sub> ×0.08	V	1	
Current consumption	I <sub>SS</sub>	V <sub>DD</sub> =3.5V	—	0.8	2.4	μA	2	
Operating voltage	V <sub>DD</sub>		0.95	—	10.0	V	1	
Output current	I <sub>OUT</sub>	Nch V <sub>DS</sub> =0.5V	V <sub>DD</sub> =1.2V	0.23	0.50	—	3	
		Pch(CMOS output) V <sub>DS</sub> =0.5V	V <sub>DD</sub> =4.8V	0.36	0.62	—	4	
Leakage current of output transistor	I <sub>LEAK</sub>	Nch(Nch open drain)	V <sub>DS</sub> =10.0 V V <sub>DD</sub> =10.0 V	—	—	0.1	μA	3
Response time	tPLH		—	—	60	μs	1	
Temperature characteristic of -V <sub>DET</sub>	$\frac{\Delta V_{DET}}{\Delta T_a}$	Ta=-40°C to +85°C	S-80815AX	—	±0.18	±0.54	mV/°C	1
			S-80816AX	—	±0.19	±0.57		
			S-80817AX	—	±0.20	±0.60		
			S-80818AX	—	±0.21	±0.63		
			S-80819AX	—	±0.22	±0.66		
			S-80820AX	—	±0.24	±0.72		
			S-80821AX	—	±0.25	±0.75		
			S-80822AX	—	±0.26	±0.78		
			S-80823AX	—	±0.27	±0.81		
			S-80824AX	—	±0.28	±0.84		
			S-80825AX	—	±0.29	±0.87		
			S-80826AX	—	±0.31	±0.93		

Detection voltage	-V <sub>DET</sub>	S-80828AX	2.744	2.800	2.858	V	1	
		S-80829AX	2.842	2.900	2.958			
		S-80830AX	2.940	3.000	3.060			
		S-80831AX	3.038	3.100	3.162			
		S-80832AX	3.136	3.200	3.264			
		S-80833AX	3.234	3.300	3.366			
		S-80834AX	3.332	3.400	3.468			
		S-80835AX	3.430	3.500	3.570			
		S-80836AX	3.528	3.600	3.672			
		S-80837AX	3.626	3.700	3.774			
		S-80838AX	3.724	3.800	3.876			
		S-80839AX	3.822	3.900	3.978			
Hysteresis width	V <sub>HYS</sub>		-V <sub>DET</sub> x0.03	-V <sub>DET</sub> x0.05	-V <sub>DET</sub> x0.08	V	1	
Current consumption	I <sub>SS</sub>	V <sub>DD</sub> =4.5V	—	0.9	2.7	μA	2	
Operating voltage	V <sub>DD</sub>		0.95	—	10.0	V	1	
Output current	I <sub>OUT</sub>	Nch V <sub>DS</sub> =0.5V	V <sub>DD</sub> =1.2V	0.23	0.50	—	3	
			V <sub>DD</sub> =2.4V	1.60	3.70	—		
		Pch(CMOS output) V <sub>DS</sub> =0.5V	V <sub>DD</sub> =4.8V	0.36	0.62	—	mA	
		Nch(Nch open drain)	V <sub>DS</sub> =10.0 V V <sub>DD</sub> =10.0 V	—	—	0.1		
Leakage current of output transistor	I <sub>LEAK</sub>			—	—	60	μs	1
Temperature characteristic of -V <sub>DET</sub>	ΔV <sub>DET</sub> ΔTa	Ta=-40°C to +85°C	S-80827AX	—	±0.32	±0.96	mV/°C	1
			S-80828AX	—	±0.33	±0.99		
			S-80829AX	—	±0.34	±1.02		
			S-80830AX	—	±0.35	±1.05		
			S-80831AX	—	±0.36	±1.08		
			S-80832AX	—	±0.38	±1.14		
			S-80833AX	—	±0.39	±1.17		
			S-80834AX	—	±0.40	±1.20		
			S-80835AX	—	±0.41	±1.23		
			S-80836AX	—	±0.42	±1.26		
			S-80837AX	—	±0.44	±1.32		
			S-80838AX	—	±0.45	±1.35		
			S-80839AX	—	±0.46	±1.38		

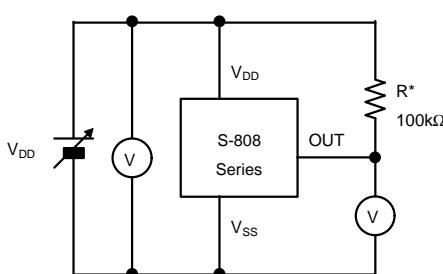
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Detection voltage	-V <sub>DET</sub>	S-80842AX	4.116	4.200	4.284	V	1	
		S-80843AX	4.214	4.300	4.386			
		S-80844AX	4.312	4.400	4.488			
		S-80845AX	4.410	4.500	4.590			
		S-80846AX	4.508	4.600	4.692			
		S-80847AX	4.606	4.700	4.794			
		S-80848AX	4.704	4.800	4.896			
		S-80849AX	4.802	4.900	4.998			
		S-80850AX	4.900	5.000	5.100			
		S-80851AX	4.998	5.100	5.202			
		S-80852AX	5.096	5.200	5.304			
		S-80853AX	5.194	5.300	5.406			
		S-80854AX	5.292	5.400	5.508			
		S-80855AX	5.390	5.500	5.610			
		S-80856AX	5.488	5.600	5.712			
Hysteresis width	V <sub>HYS</sub>		-V <sub>DET</sub> x0.03	-V <sub>DET</sub> x0.05	-V <sub>DET</sub> x0.08	V	1	
Current consumption	I <sub>SS</sub>	V <sub>DD</sub> =6.0V	—	1.0	3.0	μA	2	
Operating voltage	V <sub>DD</sub>		0.95	—	10.0	V	1	
Output current	I <sub>OUT</sub>	Nch V <sub>DS</sub> =0.5V	V <sub>DD</sub> =1.2V	0.23	0.50	—	mA	
		Pch(CMOS output) V <sub>DS</sub> =0.5V	V <sub>DD</sub> =2.4V	1.60	3.70	—		
Leakage current of output transistor	I <sub>LEAK</sub>	Nch(Nch open drain)	V <sub>DS</sub> =10.0 V V <sub>DD</sub> =10.0 V	—	—	0.1	μA	3
Response time	tPLH			—	—	60	μs	1
Temperature characteristic of -V <sub>DET</sub>	$\frac{\Delta V_{DET}}{\Delta T_a}$	Ta=-40°C to +85°C	S-80840AX	—	±0.47	±1.41	mV/°C	1
			S-80841AX	—	±0.48	±1.44		
			S-80842AX	—	±0.49	±1.47		
			S-80843AX	—	±0.51	±1.53		
			S-80844AX	—	±0.52	±1.56		
			S-80845AX	—	±0.53	±1.59		
			S-80846AX	—	±0.54	±1.62		
			S-80847AX	—	±0.55	±1.65		
			S-80848AX	—	±0.56	±1.68		
			S-80849AX	—	±0.58	±1.74		
			S-80850AX	—	±0.59	±1.77		
			S-80851AX	—	±0.60	±1.80		
			S-80852AX	—	±0.61	±1.83		
			S-80853AX	—	±0.62	±1.86		
			S-80854AX	—	±0.64	±1.92		
			S-80855AX	—	±0.65	±1.95		
			S-80856AX	—	±0.66	±1.98		

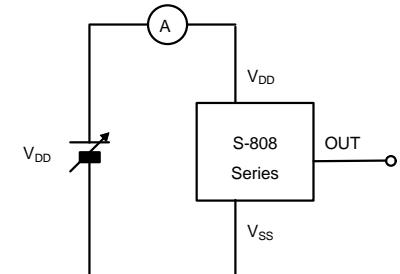
		S-80859AX	5.782	5.900	6.018		
		S-80860AX	5.880	6.000	6.120		
Hysteresis width	V <sub>HYS</sub>		-V <sub>DET</sub> x0.03	-V <sub>DET</sub> x0.05	-V <sub>DET</sub> x0.08	V	1
Current consumption	I <sub>SS</sub>	V <sub>DD</sub> =7.5V	—	1.0	3.0	μA	2
Operating voltage	V <sub>DD</sub>		0.95	—	10.0	V	1
Output current	I <sub>OUT</sub>	Nch V <sub>DS</sub> =0.5V	V <sub>DD</sub> =1.2V	0.23	0.50	—	mA
		V <sub>DS</sub> =0.5V	V <sub>DD</sub> =2.4V	1.60	3.70	—	
		Pch(CMOS output) V <sub>DS</sub> =0.5V	V <sub>DD</sub> =8.4V	0.59	0.96	—	4
		Nch(Nch open drain)	V <sub>DS</sub> =10.0 V V <sub>DD</sub> =10.0 V	—	—	0.1	
Leakage current of output transistor	I <sub>LEAK</sub>					μA	3
Response time	tPLH		—	—	60	μs	1
Temperature characteristic of -V <sub>DET</sub>	$\frac{\Delta V_{DET}}{\Delta T_a}$	Ta=-40°C to +85°C	S-80857AX	—	$\pm 0.67$	$\pm 2.01$	mV/°C
			S-80858AX	—	$\pm 0.68$	$\pm 2.04$	
			S-80859AX	—	$\pm 0.69$	$\pm 2.07$	
			S-80860AX	—	$\pm 0.71$	$\pm 2.13$	

## ■ Test Circuits

(1)

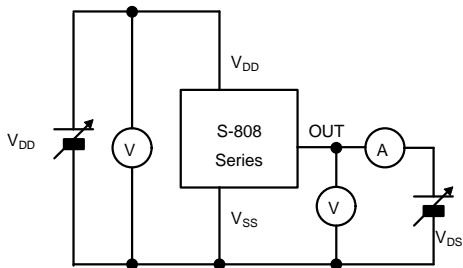


(2)



\* R is unnecessary for CMOS output products.

(3)



(4)

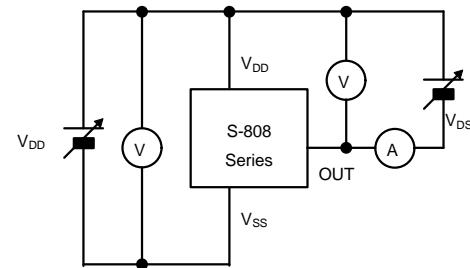


Figure 4

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Example : For the S-80808AN, detection voltage lies in the range of  $0.784 \leq (-V_{DET}) \leq 0.816$ .

This means that  $-V_{DET}$  is 0.784 in a product while  $-V_{DET}$  is 0.816 in another of the same S-80808AN.

## 2. Release voltage ( $+V_{DET}$ )

The release voltage  $+V_{DET}$  is the voltage at which the output returns (is "released") to high. This release voltage varies slightly among products of the same type. The variation of voltages between the specified minimum [ $(+V_{DET})_{min.}$ ] and maximum [ $(+V_{DET})_{max.}$ ] values is called the release voltage range (See Figure 6).

Example : For the S-80808AN, the release voltage lies in the range of  $0.802 \leq (+V_{DET}) \leq 0.867$ . This means that  $+V_{DET}$  is 0.802 in a product while  $+V_{DET}$  is 0.867 in another of the same S-80808AN.

**Remark:** Although the detection voltage and release voltage overlap in the range of 0.802 V to 0.816 V,  $+V_{DET}$  will always be larger than  $-V_{DET}$ .

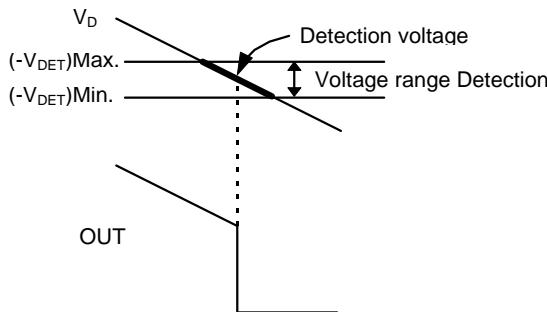


Figure 5

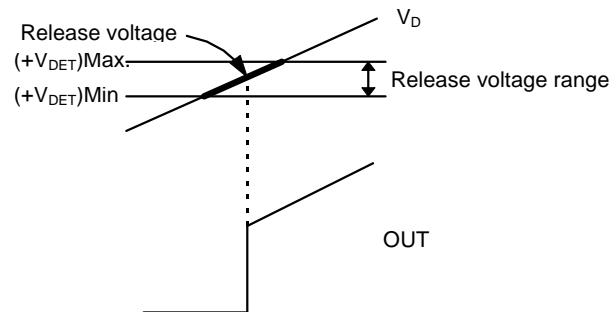


Figure 6

## 3. Hysteresis width ( $V_{HYS}$ )

The hysteresis width is the voltage difference between the detection voltage and the release voltage ( $B-A=V_{HYS}$  in Figure 10). By giving a device hysteresis, trouble such as noise at the input is avoided.

## 4. Through-type current

Through-type current refers to the current which flows instantaneously at the time of detection and release of a voltage detector. Through-type current is large in CMOS output devices, and also flows to some extent in Nch open-drain output devices.

have disappeared, and the output goes back from low to high. A through-type current is again generated, a voltage appears, and the process repeats. This unstable condition is referred to as oscillation.

#### ▲ Misimplementation with input voltage divider

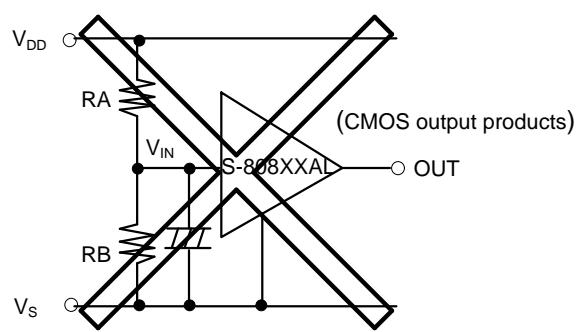


Figure 7

#### ■ Standard Circuit

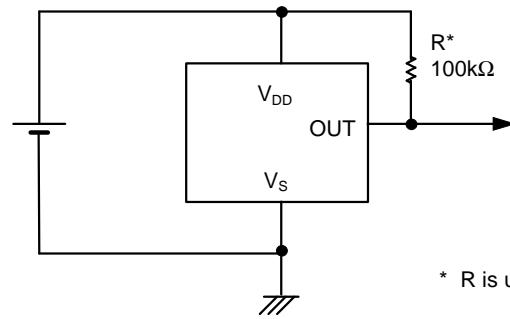


Figure 8

\* R is unnecessary for\* CMOS output products

- (2) When power supply voltage  $V_{DD}$  goes below  $+V_{DET}$ , the output maintains the power supply voltage level, as long as  $V_{DD}$  remains above the detection voltage  $-V_{DET}$ . When  $V_{DD}$  does fall below  $-V_{DET}$  (A in Figure 10), the Nch transistor goes ON, the Pch transistor goes OFF, and  $V_{SS}$  appears at the output. With the Nch transistor N 1 of Figure 9 ON, the comparator input voltage is  $RB/(RA+RB) \times V_{DD}$ .
- (3) When  $V_{DD}$  falls below the minimum operating voltage, the output becomes undefined. However, output will revert to  $V_{DD}$  if a pull-up has been employed.
- (4)  $V_{SS}$  will again be output when  $V_{DD}$  rises above the minimum operating voltage.  $V_{SS}$  will continue to be output even when  $V_{DD}$  surpasses  $-V_{DET}$ , as long as it does not exceed the release voltage  $+V_{DET}$ .
- (5) When  $V_{DD}$  rises above  $+V_{DET}$  (B in Figure 10), the Nch transistor goes OFF, the Pch transistor goes ON, and  $V_{DD}$  appears at the output.

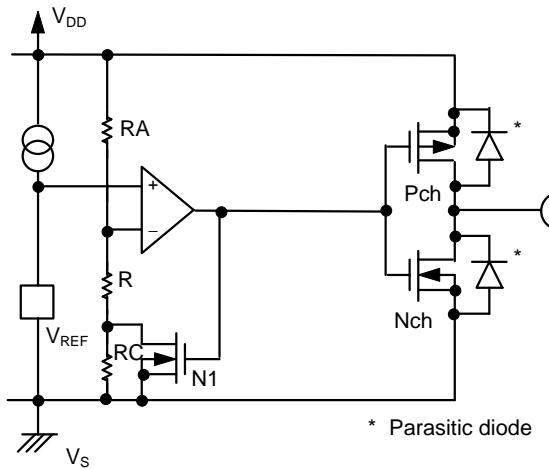


Figure 9

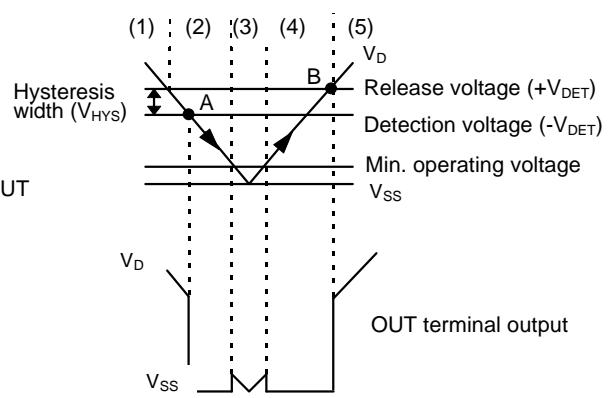
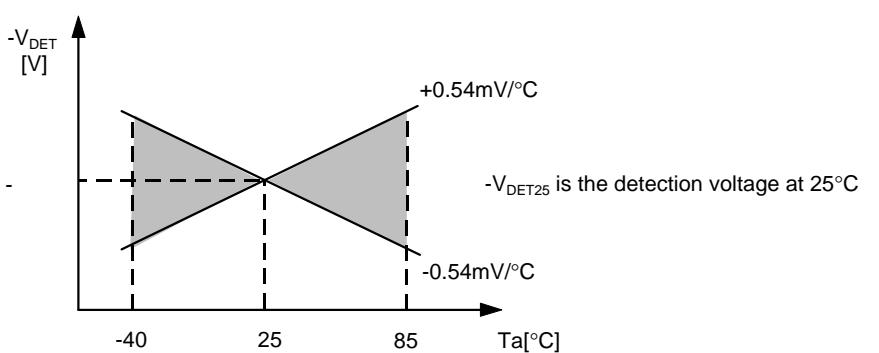


Figure 10



**Figure 11**

(2) Temperature characteristics of release voltage

The temperature factor  $\left( \frac{\Delta V_{DET}}{\Delta T_a} \right)$  of the release voltage is calculated by the temperature factor of the detection voltage as follows:

$$\frac{\Delta V_{DET}}{\Delta T_a} = \frac{+V_{DET}}{-V_{DET}} \times \frac{\Delta V_{DET}}{\Delta T_a}$$

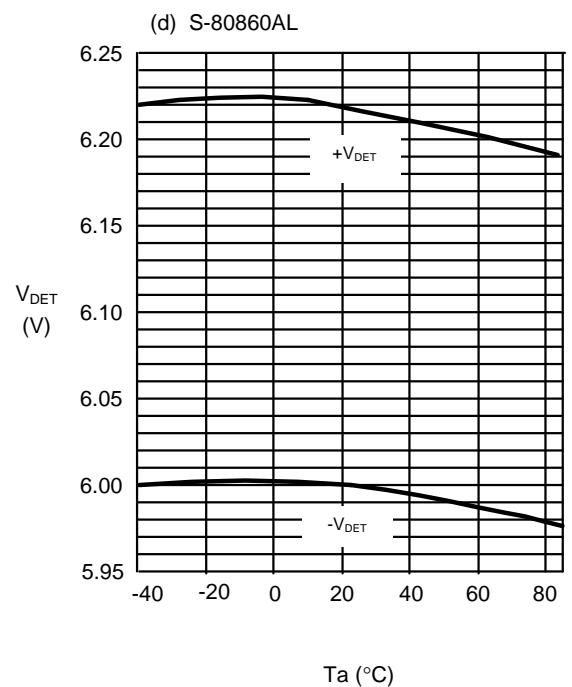
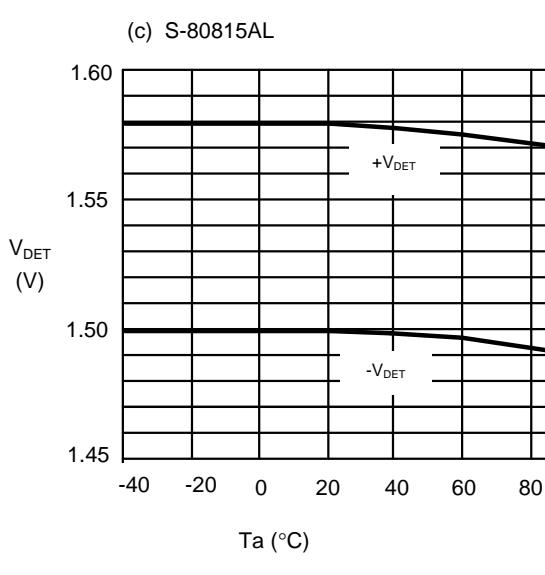
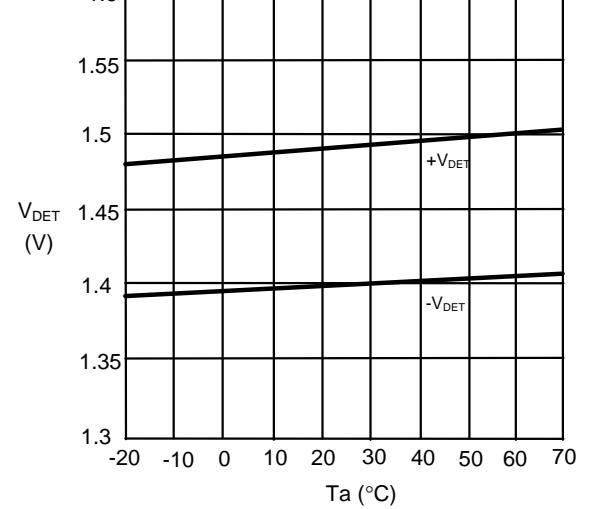
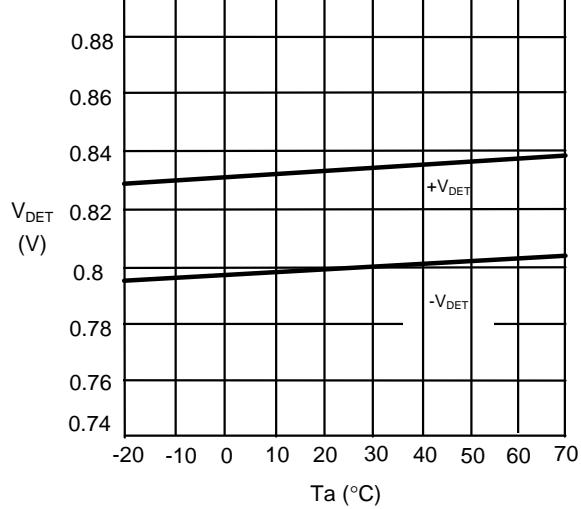
The temperature factor of the release voltage has a same sign characteristics as the temperature factor of the detection voltage.

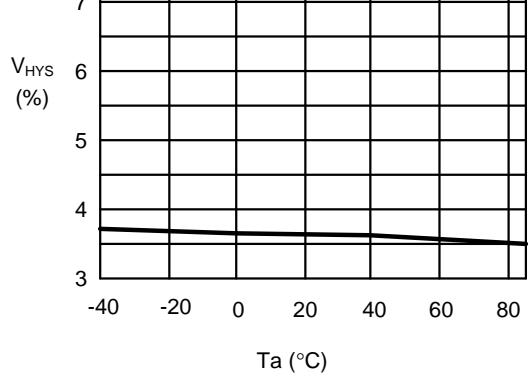
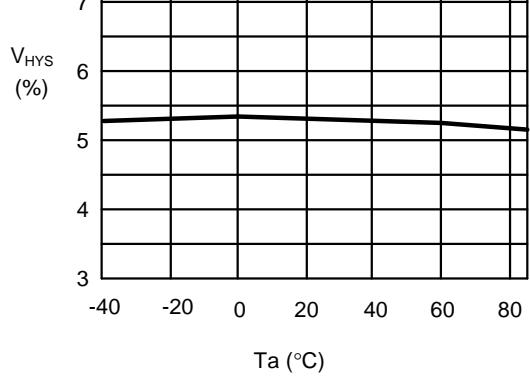
(3) Temperature characteristics of hysteresis voltage

The temperature characteristics of hysteresis voltage  $\left( \frac{\Delta V_{DET}}{\Delta T_a} - \frac{\Delta V_{DET}}{\Delta T_a} \right)$  is calculated as

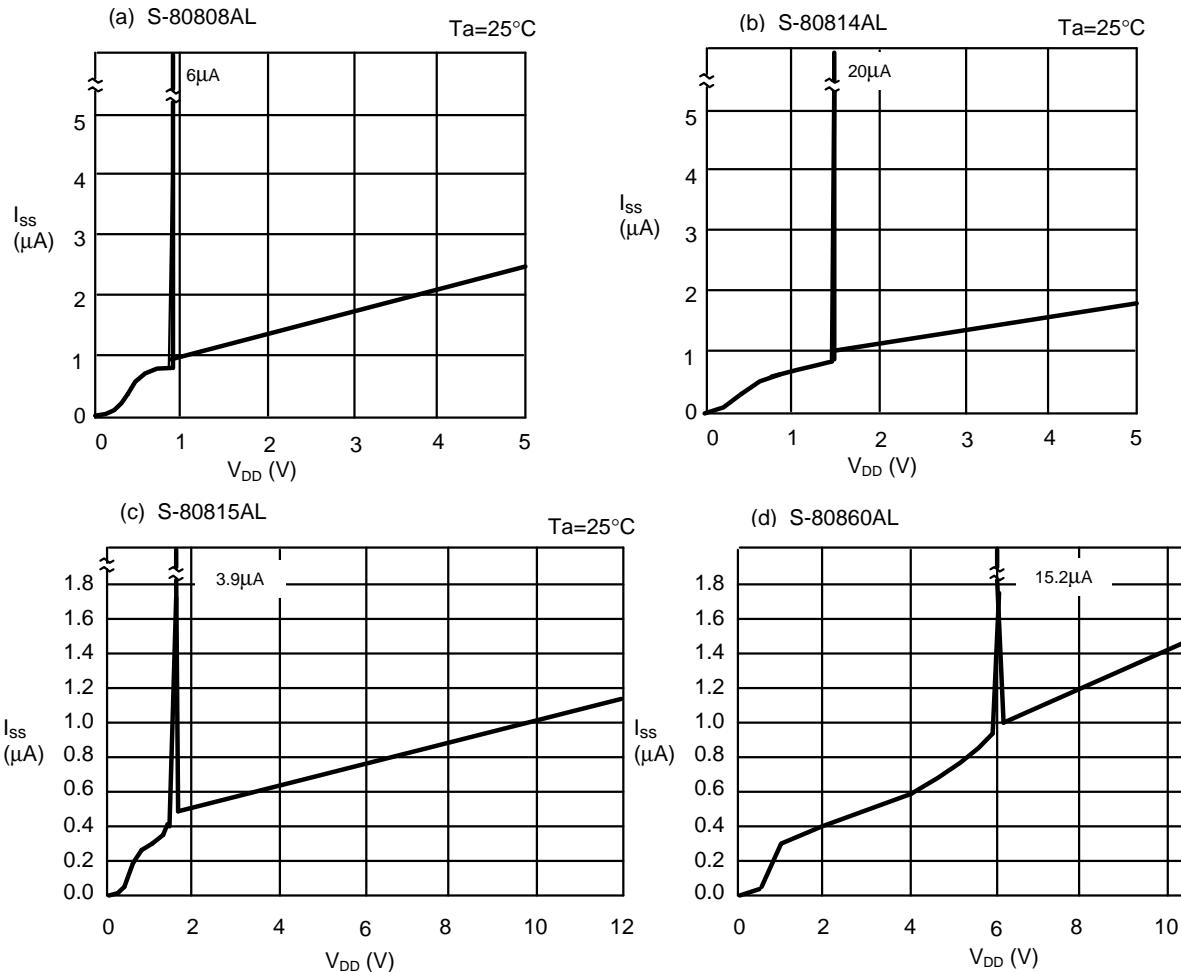
$$\frac{\Delta V_{DET}}{\Delta T_a} - \frac{\Delta V_{DET}}{\Delta T_a} = \frac{V_{HY}}{-V_{DET}} \times \frac{\Delta V_{DET}}{\Delta T_a}$$

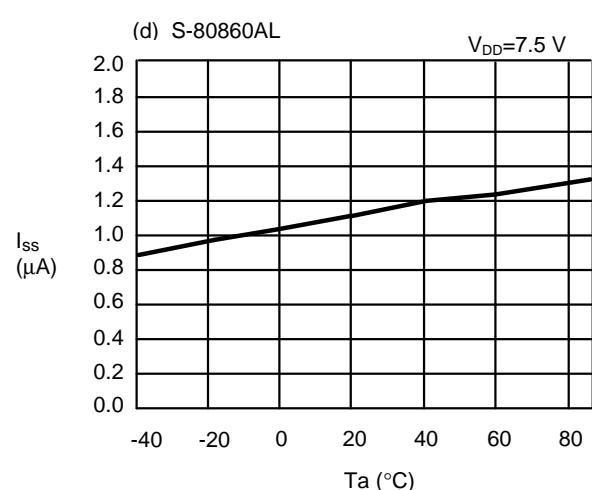
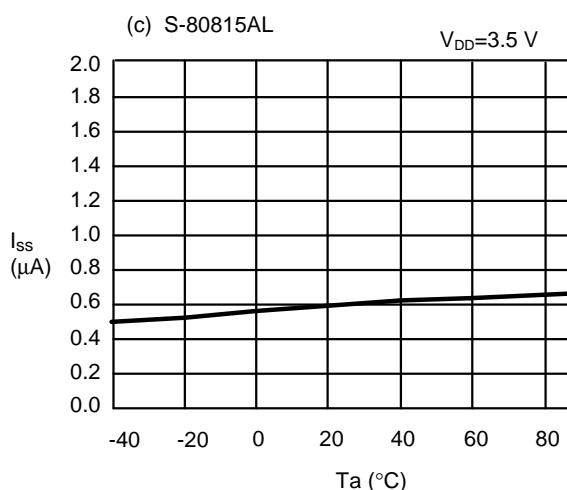
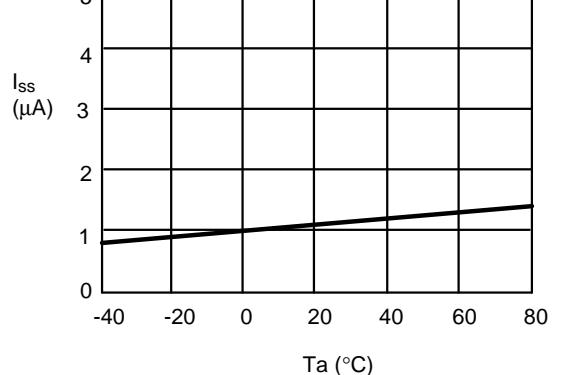
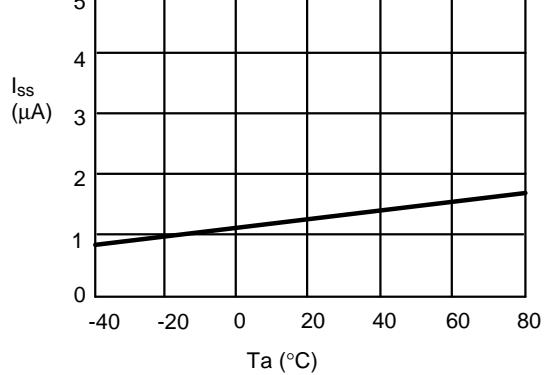
Remark: An example of temperature characteristics of (1) to (3) is shown on pages 16 and 17.

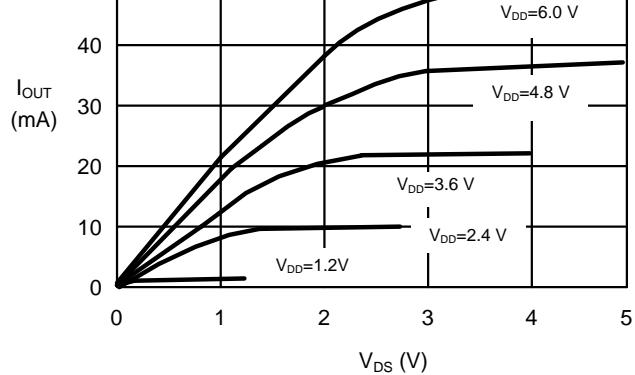
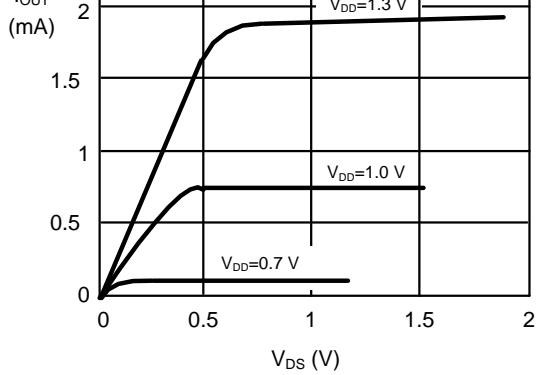




(3) Current consumption ( $I_{\text{SS}}$ ) - Input voltage ( $V_{\text{DD}}$ )

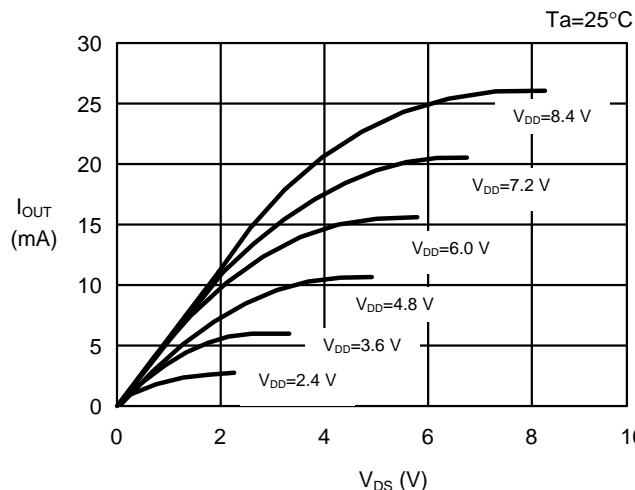
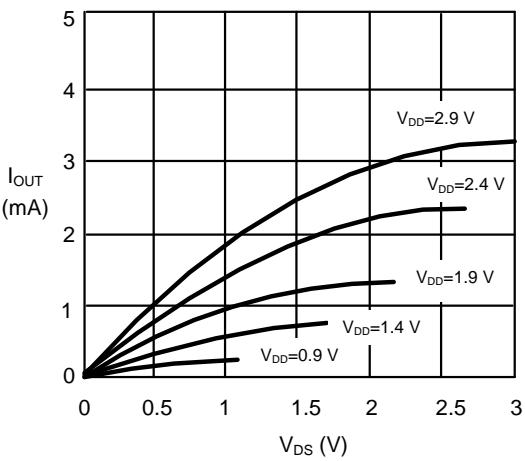






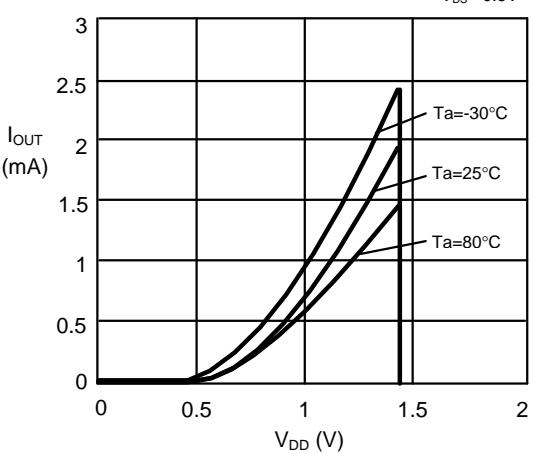
(6) Pch transistor output current ( $I_{OUT}$ ) -  $V_{DS}$

(a) S-80808AL

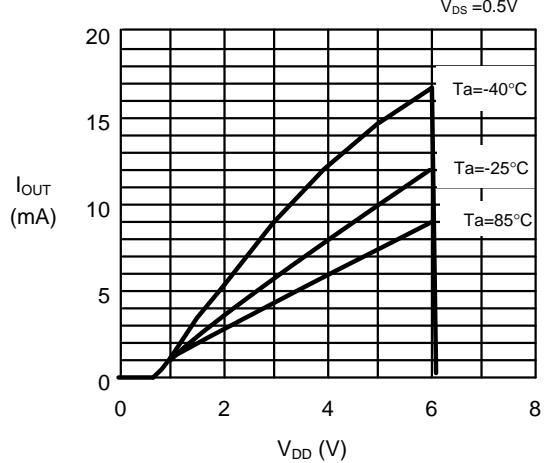


(7) Nch transistor output current ( $I_{OUT}$ ) - Input voltage( $V_{DD}$ )

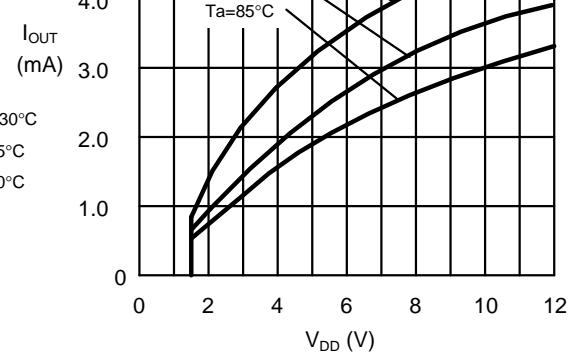
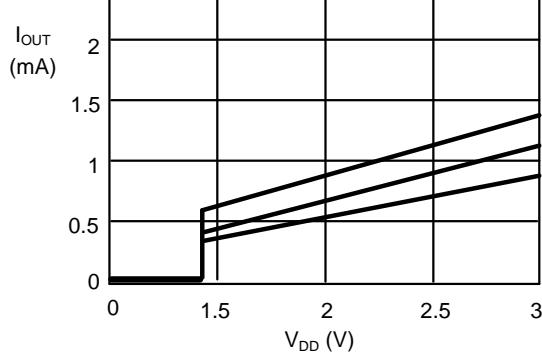
(a) S-80814AL/AN



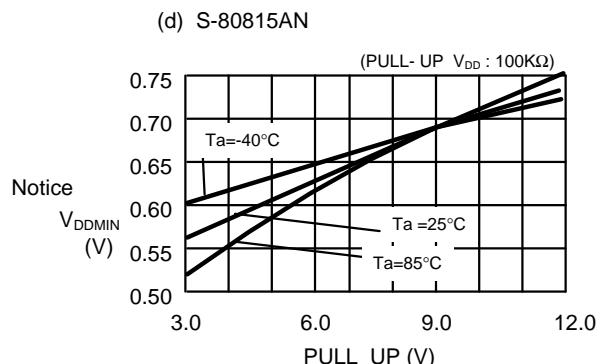
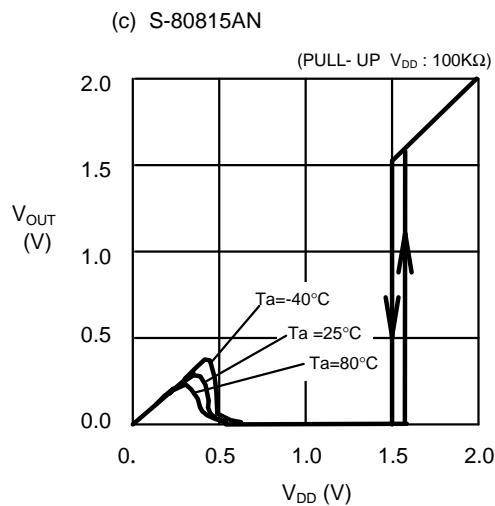
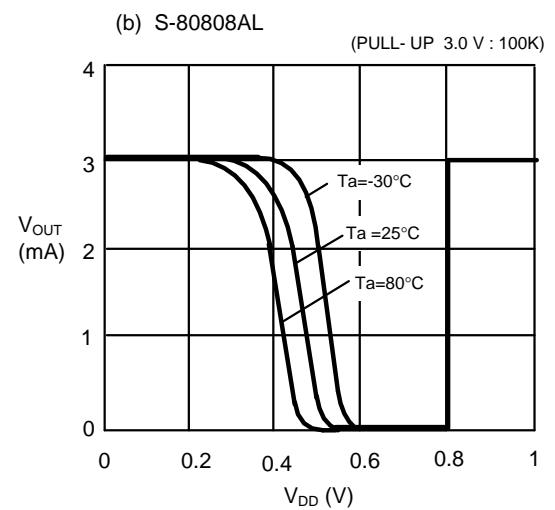
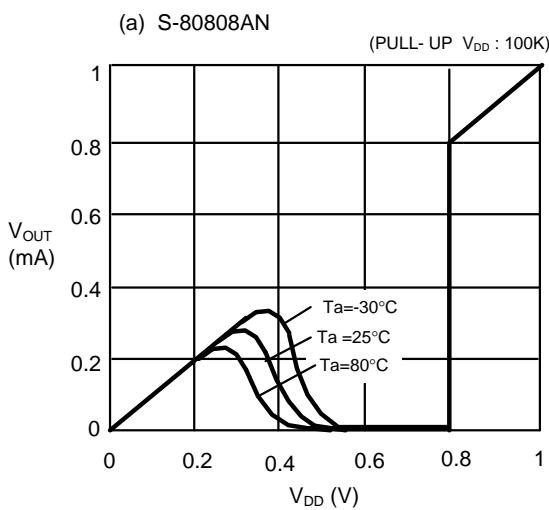
(b) S-80860AL/AN



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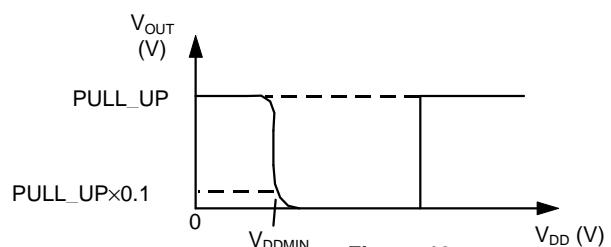


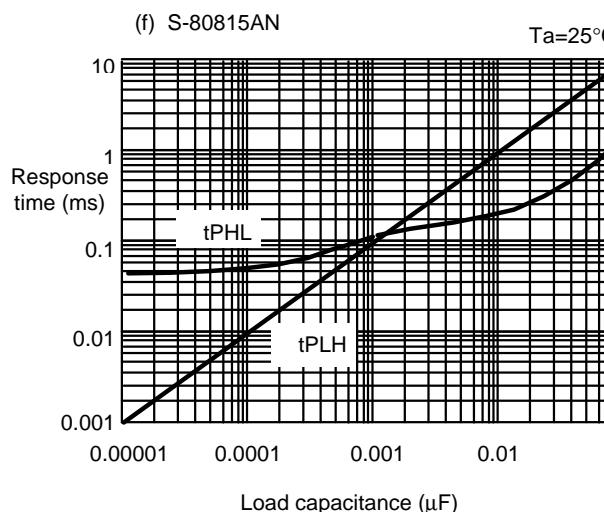
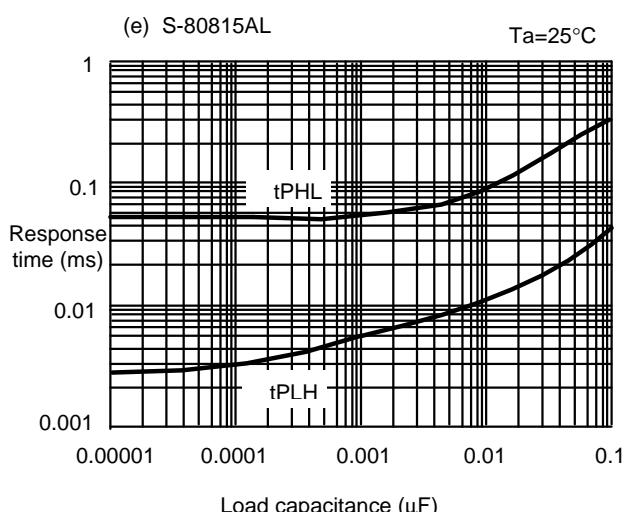
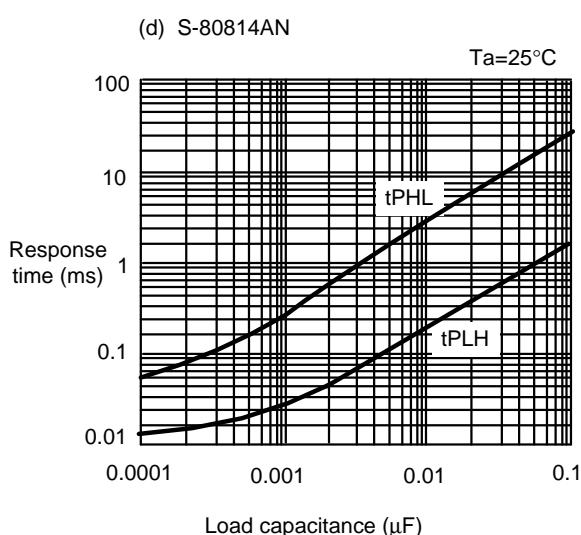
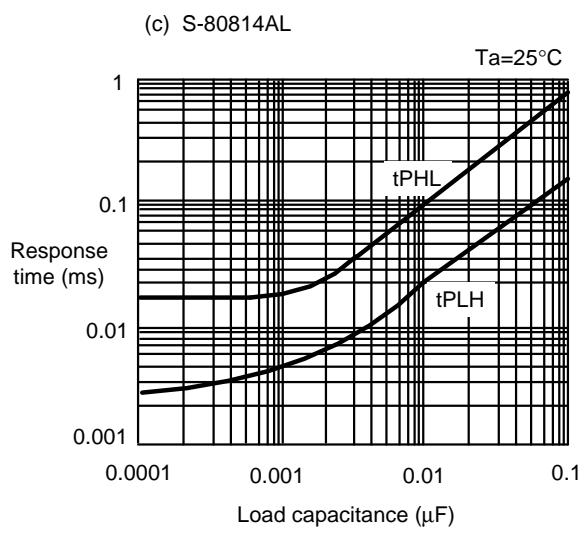
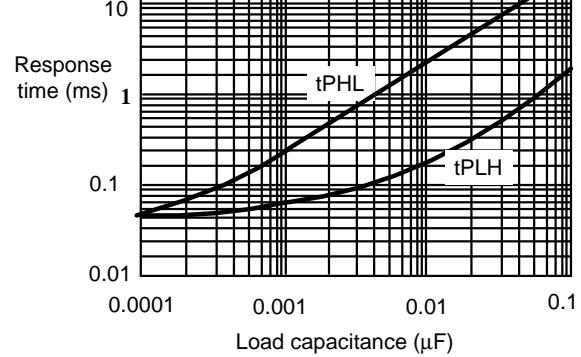
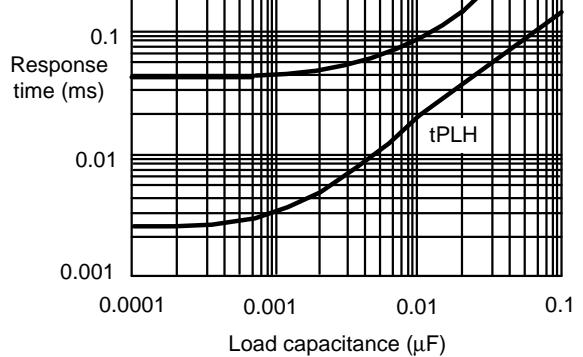
(9) Minimum operating voltage



Remark:

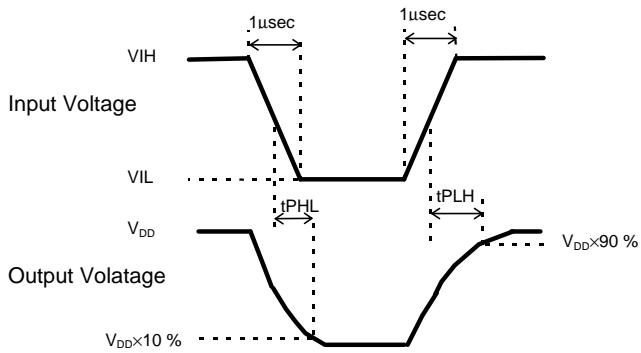
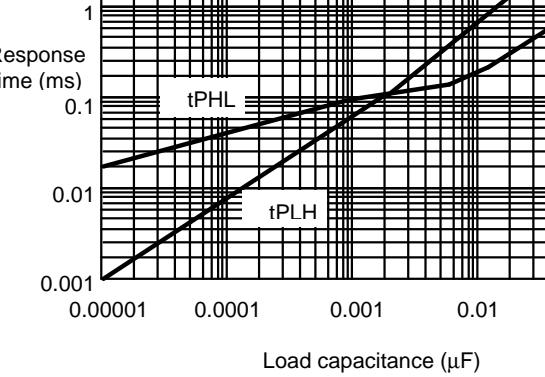
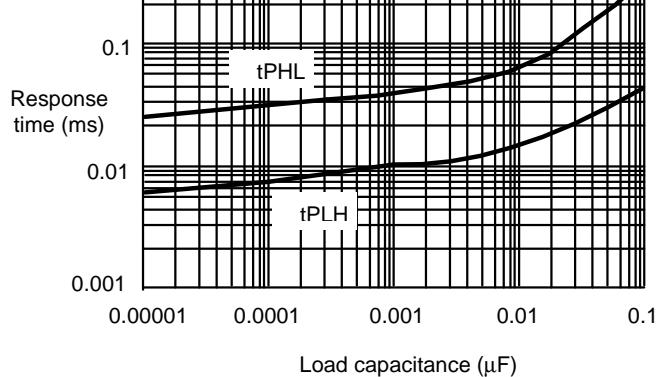
$V_{DDMIN}$  is defined with  $V_{DD}$  when  $V_{OUT}$  goes below 10% of the PULL UP voltage as shown in Figure 12 when raising  $V_{DD}$  from 0 V.





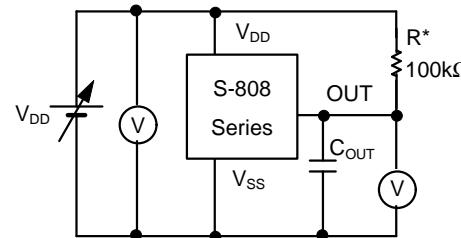
Seiko Instruments Inc.

Response



(a) - (d) :  $VIH=5.0V$ ,  $VIL=0.7V$   
(e) - (h) :  $VIH=10V$ ,  $VIL=0.95V$

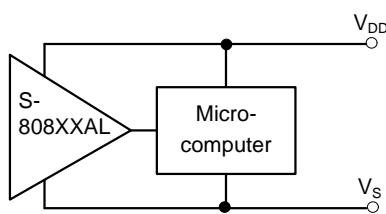
Figure 13



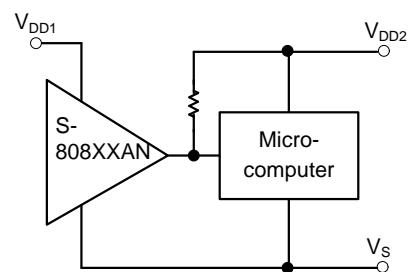
\* 'R' is not needed for CMOS output products.

Figure 14

Reset circuits protect microcomputers in the event of current being momentarily switched off or low voltage. With the S-808 Series which has a low operating voltage, a high-precision detection voltage and hysteresis characteristics, reset circuits shown in Figures 15 to 16 can be easily constructed.



**Figure 15**

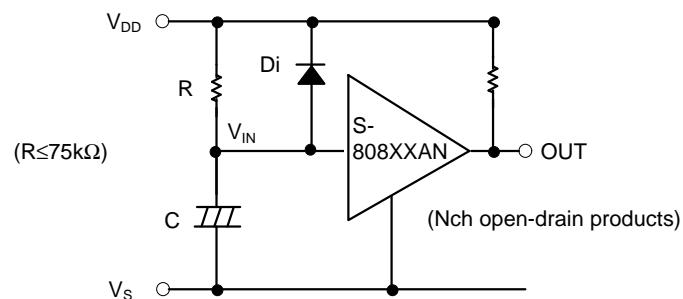


(Nch open-drain output products only)

**Figure 16**

## 2. Addition of power-on reset circuit

A power-on reset circuit can be constructed using Nch open-drain product of S-808 Series.



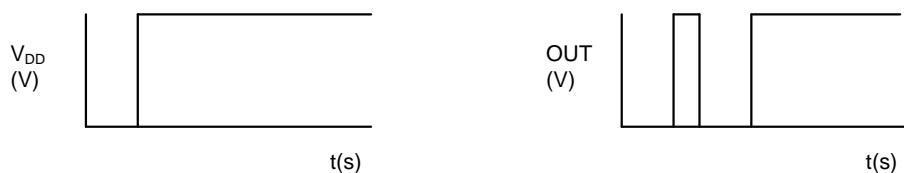
Note 1: R should be 75 kΩ or less for purpose of protection against oscillation.

Note 2: Di instantaneously discharges the electric charge stored by C at the falling of the power. Di is not necessary if delay in falling time is normal.



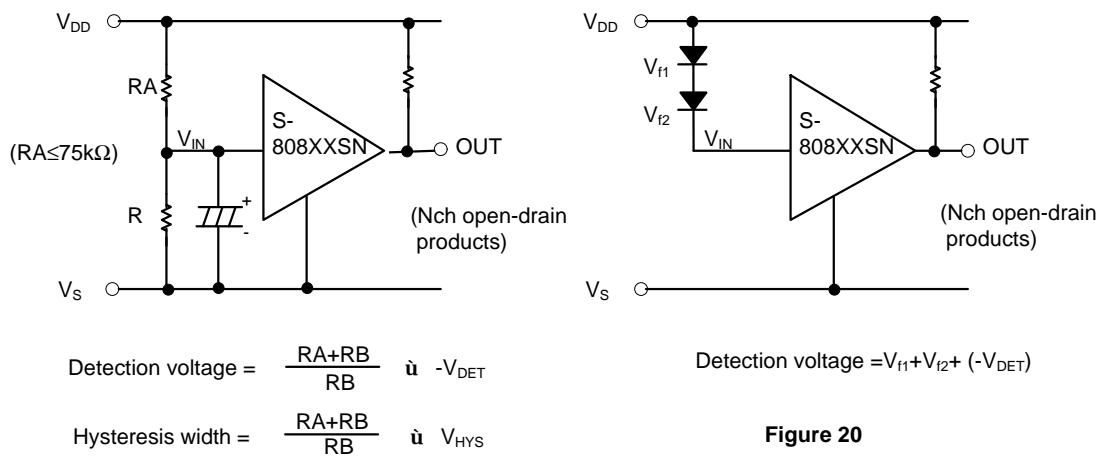
**Figure 17**

Note 3: When the power steeply rises, output may goes high for a instant due to the IC inconstant region characteristics (output voltage is unstable in the region under minimum operating voltage) as shown in Figure. 18.



**Figure 18**

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Note1: If RA and RB are large, the hysteresis width may be larger than the value given by the formula above due to through-type current (which flows slightly in Nch open-drain circuit).

Note2: RA should be 75kΩ or less for purpose of protection against oscillation.

**Figure 19**

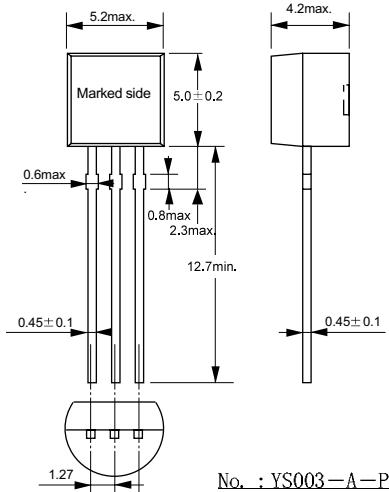
## ■ Remarks

- In CMOS output products of the S-808 Series, through-type current flows when the device is detecting or releasing. If a high impedance is connected to the input, oscillation may be caused due to the fall of the voltage by the through-type current when lowering the voltage during releasing.
- When designing for mass production using an application circuit described herein, take the product deviation and temperature characteristic into consideration.
- Seiko Instruments Inc. shall not bear any responsibility for the patents on the circuits described herein.

## ■ TO-92

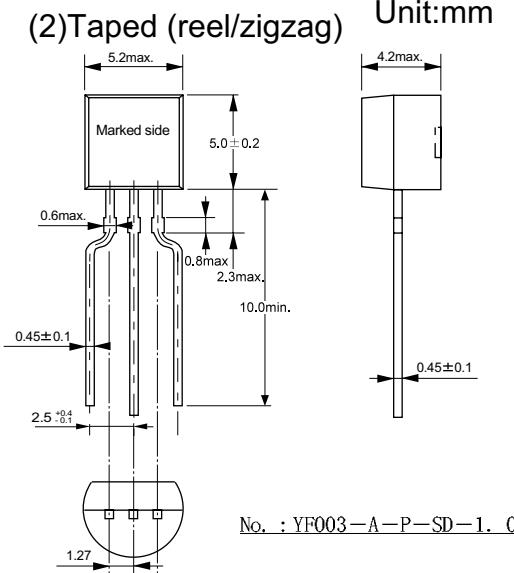
### ● Dimensions

#### (1) Loose



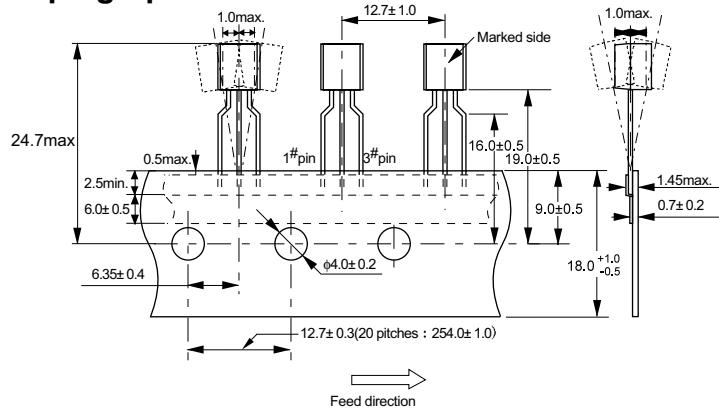
YF003-A 990531

#### (2) Taped (reel/zigzag)

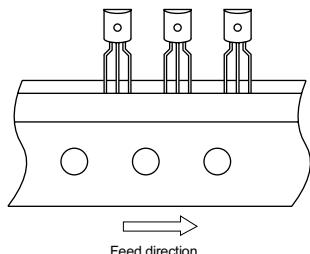


Unit:mm

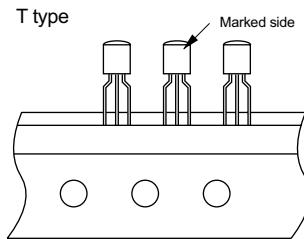
### ● Taping Specifications



Ftype



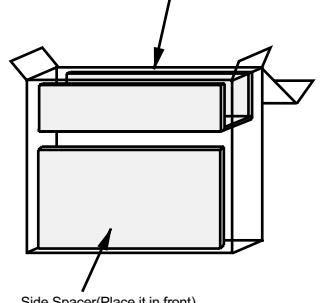
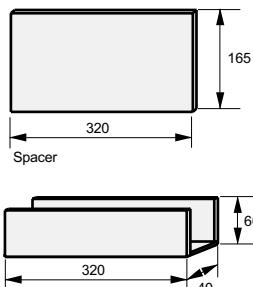
T type



No. : YF003-A-C-SD-1\_0

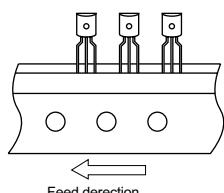
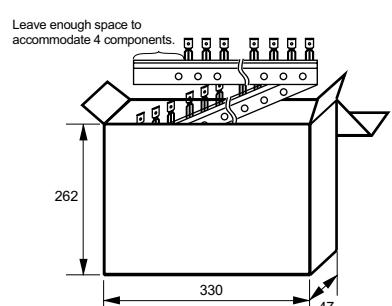
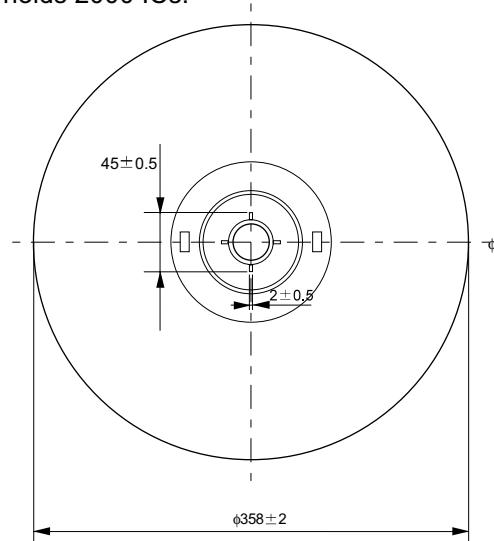
### ● Switch-back(wrap) Specifications

Side Spacer



### ● Reel Specifications

1 reel holds 2000 ICs.



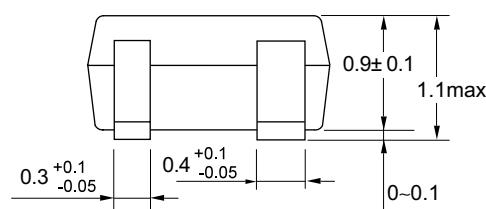
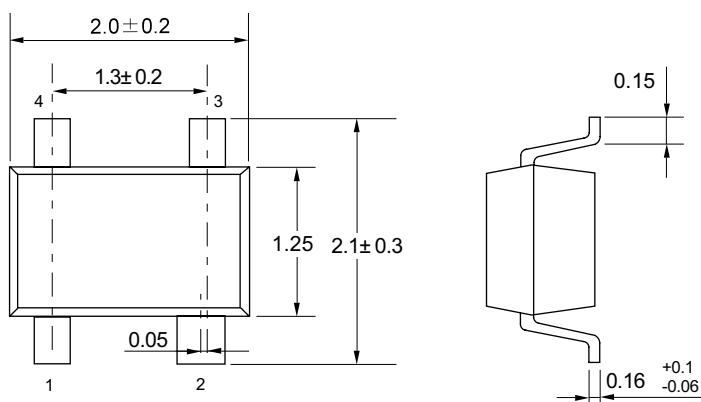
No. : YF003-A-Z-SD-1\_0

## ■ SC-82AB

NP004-A 990531

### ● Dimensions

Unit:mm

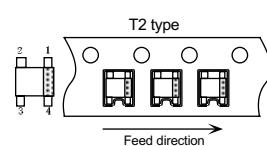
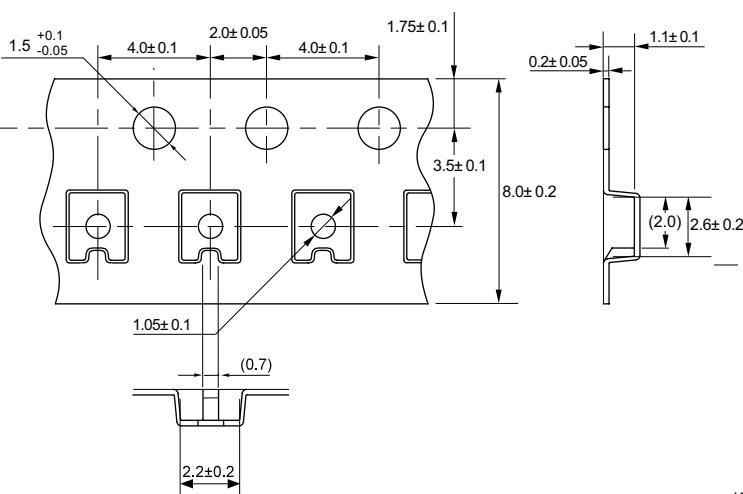


No. : N P 0 0 4 - A - P - S D - 1 . 0

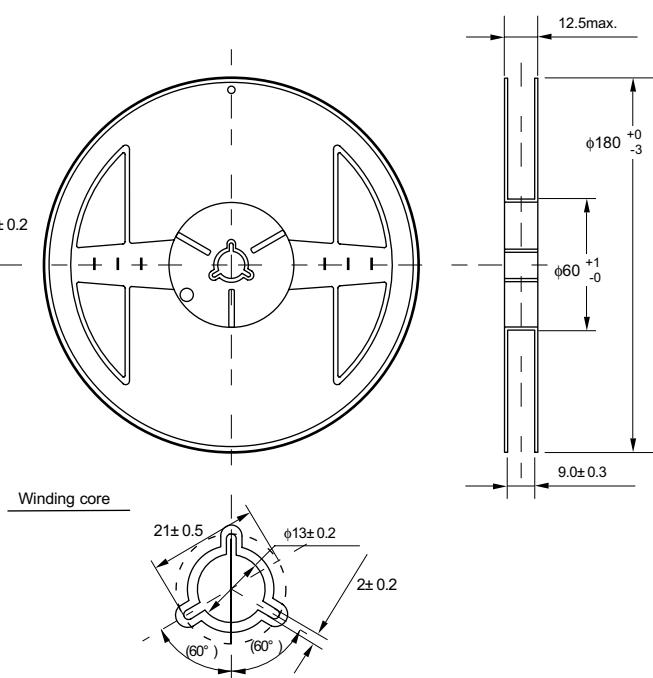
### ● Taping Specifications

### ● Reel Specifications

1 reel holds 3000 ICs.



No. : N P 0 0 4 - A - C - S D - 1 . 0



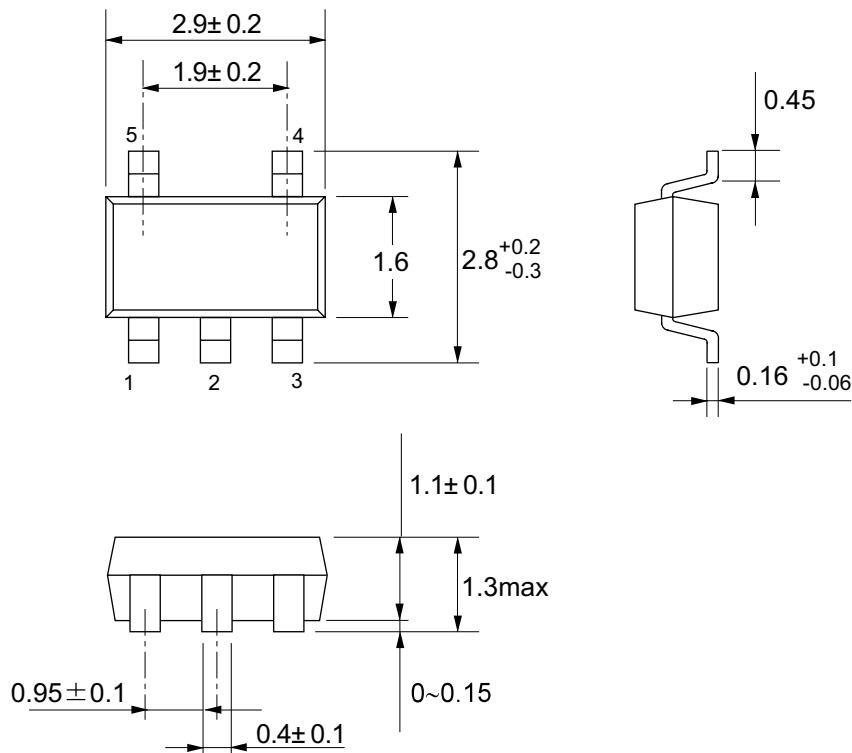
No. : N P 0 0 4 - A - R - S D - 1 . 0

## SOT-23-5

MP005-A 990531

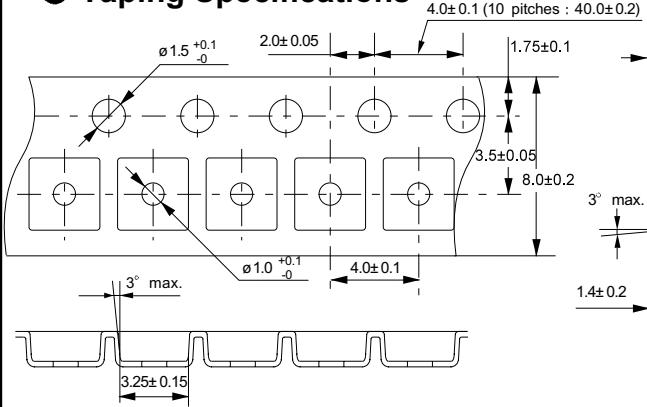
Unit : mm

### Dimensions



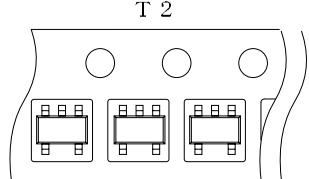
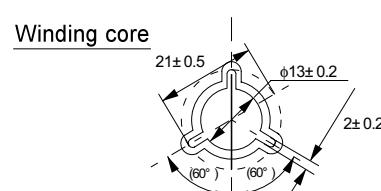
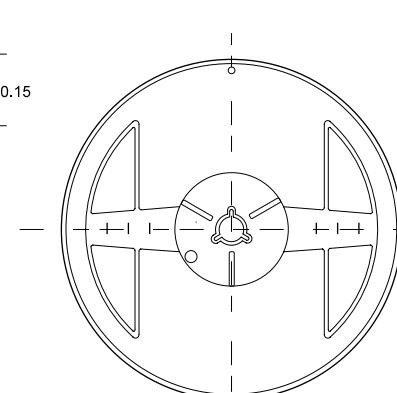
No. : MP 0 0 5 - A - P - S D - 1 . 0

### Taping Specifications



### Reel Specifications

1 reel holds 3000 ICs.



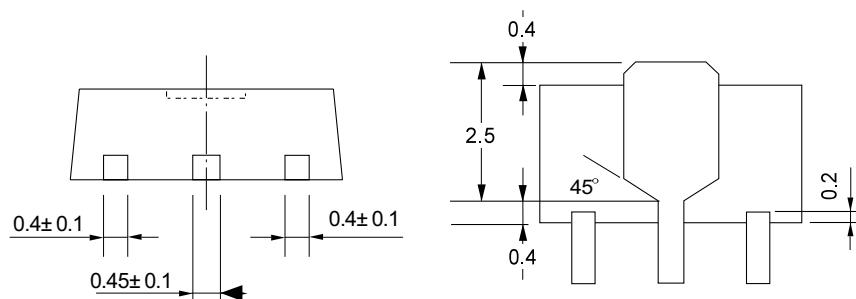
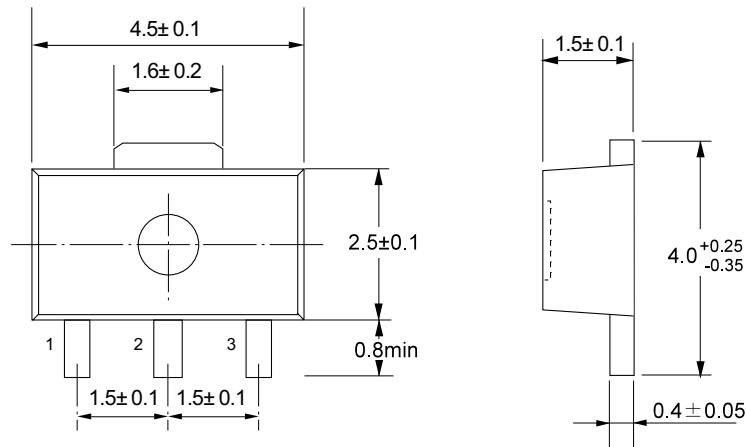
No. : M P 0 0 5 - A - C - S D - 1 . 0

## SOT-89-3

UP003-A 990531

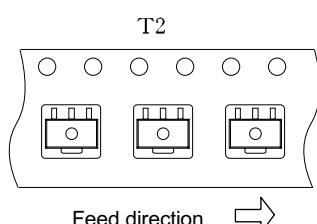
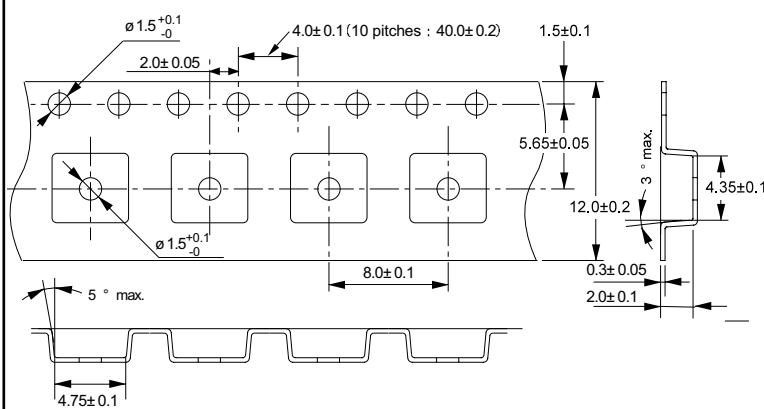
### Dimensions

Unit:mm



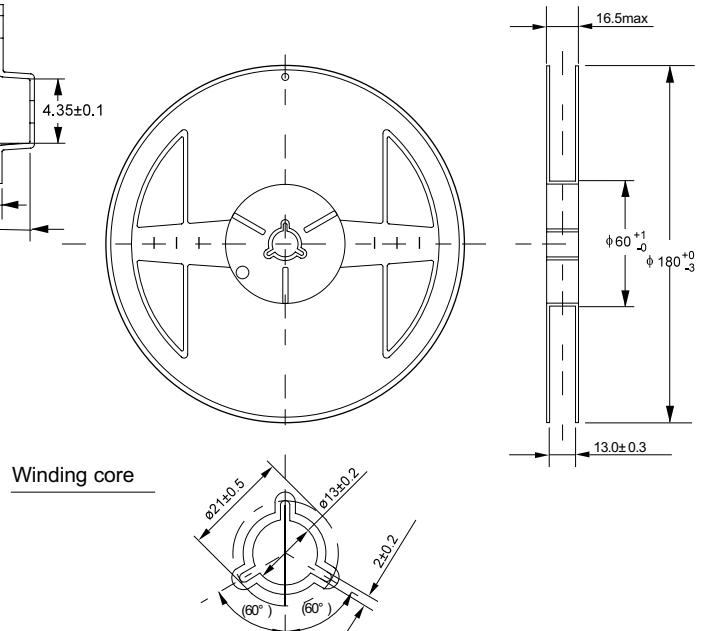
No. : U P 0 0 3 - A - P - S D - 1 . 0

### Taping Specifications



### Reel Specifications

1 reel holds 1000 ICs.



No. : U P 0 0 3 - A - C - S D - 1 . 0

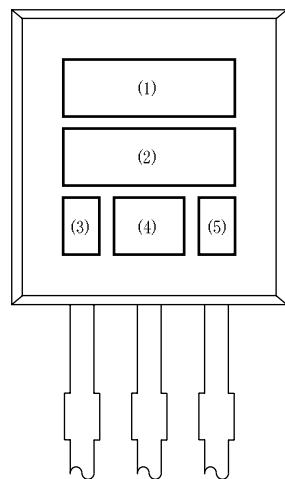
No. : U P 0 0 3 - A - R - S D - 1 . 0

## ■Markings

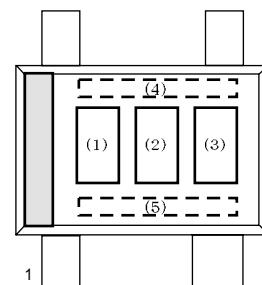
808

990603

### ● TO-92



### ● SC-82AB



(1) to (3) : Product name (abbreviation)

(4) and (5) : Product lot

No. : N P 0 0 4 - A - M - S 1 - 1 . 0

(1) to (2) : Product name

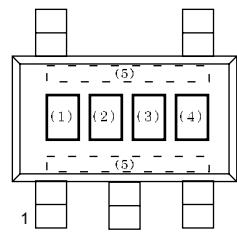
(3) : Year of assembly

(4) : Month of assembly and week code

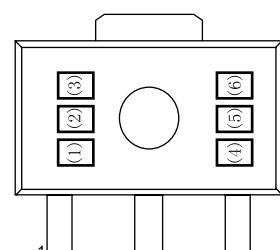
(5) : Wafer lot No. (last digit)

No. : Y F 0 0 3 - A - M - S 1 - 1 . 0

### ● SOT-23-5



### ● SOT-89-3



(1) to (3) : Product name (abbreviation)

(4) : Month of assembly

(5) : Dot on one side  
(Year and week of assembly)

(1) to (3) : Product name (abbreviation)

(4) : Year of assembly

(5) : Month of assembly

(6) : Week of assembly

No. : M P 0 0 5 - A - M - S 1 - 1 . 0

No. : U P 0 0 3 - A - M - S 1 - 1 . 0

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